

PRODUCT NUMBER  
10118528-6XX-06LF

PLATING \_\_\_\_\_  
6 = 0.38µm Au/GXT FULL PLATED

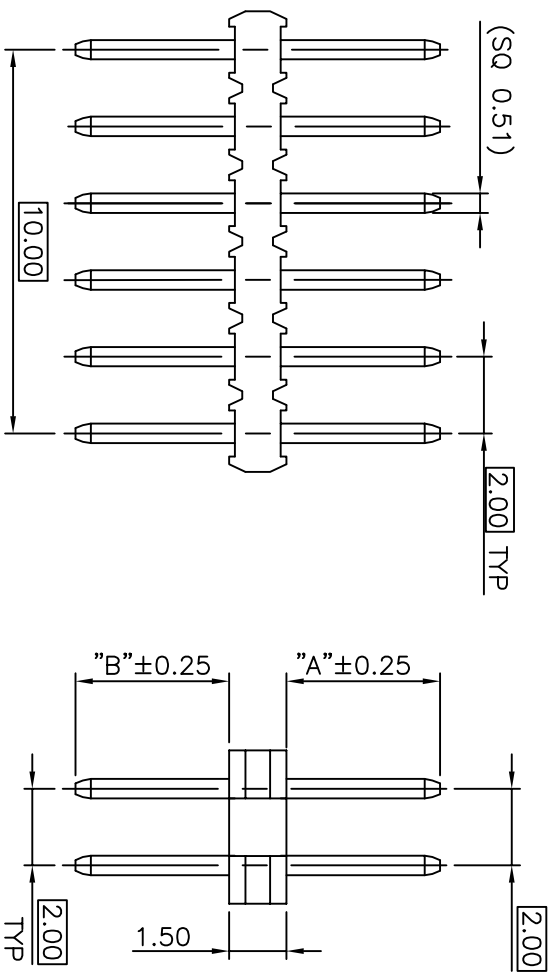
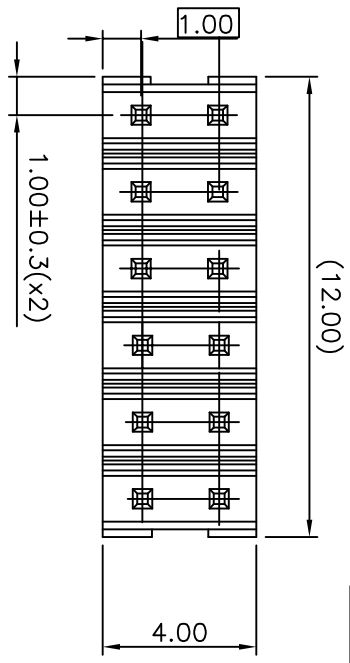
ROHS COMPATIBLE PRODUCT  
SEE NOTE 5

NB OF POSITIONS PER ROW

PIN STYLE	DIM"A"	DIM"B"
01	4.00	4.00
02	5.90	5.90
03	8.40	8.40
04	9.80	9.80
05	3.25	3.25

KIT NUMBER	MADE FROM	QTY
10118528-0003LF	10118528-603-06LF	144

PACKAGING NOTE 6



NOTES:

- MATERIAL HOUSING: HIGH TEMP. THERMOPLASTIC UL 94V-0, COLOR BLACK
- MATERIAL TERMINAL: COPPER ALLOY
- 7N MIN. PIN RETENTION IN EITHER DIRECTION.
- STANDARD PACKAGING IN PLASTIC BOX
- ROHS COMPATIBLE PRODUCT SPECIFICATIONS

a - PLATING:

- "LF" MEANS THE PRODUCT IS LEAD-FREE, 2µm MINIMUM MATTE TIN OVER 1.27µm MINIMUM NICKEL UNDERPLATE.

b - MANUFACTURING PROCESS COMPATIBILITY

- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.

- COMPATIBLE TO REFLOW PROCESS 260°C MAX FOR 30 SECONDES

c - LABELLING:

- MEETS PACKAGING SPECS AS PER GS-14-920

d - LEGAL STATEMENT: SEE GS-47-0004

- PACKAGING IN PLASTIC BOX : 144PCS

mat'l. code		surface		tolerance		projection		product family	
ltr	ecn no	dr	date	ISO 1302	ISO 406	ISO	M01	MINITEK	MINITEK
A	F11-0098	LMU	11.09.13	tolerances unless otherwise specified	X	±0.3	mm	UNSH HEADER	UNSH HEADER
B	F12-0078	JCO	12.06.26	linear	XX	±0.13	mm	2.00 mm VERTICAL TMT	2.00 mm VERTICAL TMT
C	F12-0088	JCO	12.12.07	linear	XXX	±0.05	mm		
D	B-19190	LMU	14.10.24	dr	LMULIN	06.06.11	mm		
				engr	J.COMPAGNONI	06.06.11			
				chr	J.M.C	06.06.11			
				appd					
sheet	revision								
index	sheet								